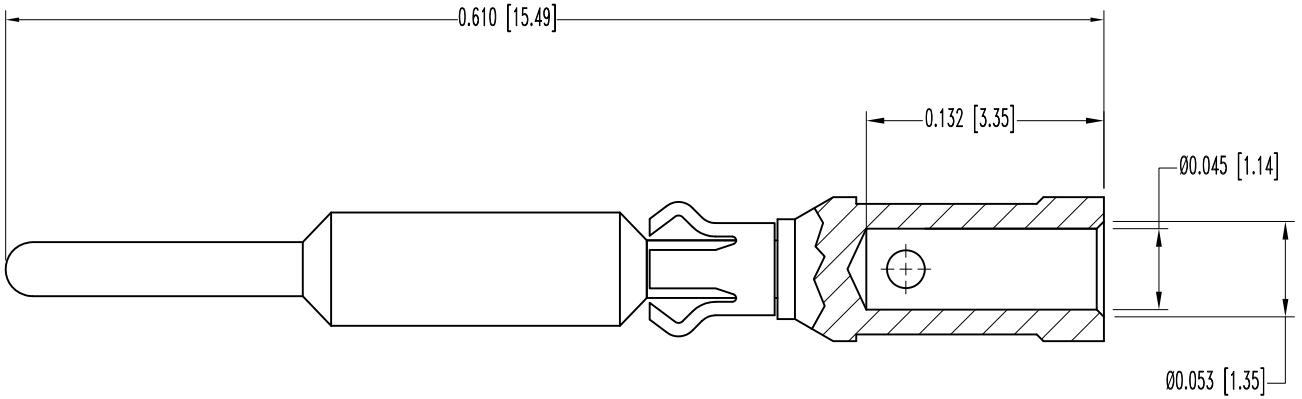
THIS DRAWING CONTAINS INFORMATION PROPRIETARY TO POSITRONIC AND IT'S SUBSIDIARIES. POSITRONIC BELIEVES THE DATA ON THIS DRAWING TO BE RELIABLE, SINCE THE TECHNICAL INFORMATION IS GIVEN FREE OF CHARGE, THE USER EMPLOYS SUCH INFORMATION AT HIS OWN DISCRETION AND RISK. POSITRONIC ASSUMES NO RESPONSIBILITY FOR RESULTS OBTAINED OR DAMAGES INCURRED FROM USE OF SUCH INFORMATION IN WHOLE OR IN PART.

DATE	REV	REVISION RECORD	APP	DR	CK
1-5-06	NC	ECO 25314	RCW	YK	TK
2-22-12	A	ECO 35259	COLE	BS	COLE
3-12-12	B	ECO 35351	COLE	BS	COLE



NOTES:

1. MATERIALS AND FINISHES:
   CONTACT: COPPER ALLOY, 0.000015 [0.38µ] GOLD OVER NICKEL PLATE.
   RETAINING CLIP: BERYLLIUM COPPER: GOLD FLASH OVER NICKEL PLATE.
2. DETAILED PRODUCT, MECHANICAL, AND ELECTRICAL INFORMATION IS AVAILABLE IN THE LATEST HIGH DENSITY RECTANGULAR PRODUCT PUBLICATION. VISIT CONNECTPOSITRONIC.COM/PRODUCTS/54/HIGHDENSITYRECTANGULAR OR CONNECTPOSITRONIC.COM.
3. CONTACTS ARE ROHS COMPLIANT PER ROHS DIRECTIVE 2002/95/EC OF 27 JAN 2003.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].

POSITRONIC INDUSTRIES INC.
www.connectpositronic.com
FSCM 28198

DECIMAL TOL. ±0.015 [0.38]
ANGULAR TOL. ±5°

SGMC SERIES

SCALE N.T.S.

DRAWN BY YK

APPROVED BY R WILLIAMS

TITLE MC420N/AA

DATE 1-5-06

DRAWING NUMBER SK6922

REV. B

Downloaded from Arrow.com.